

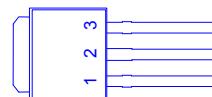
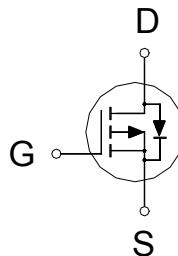
NIKO-SEM

**P-Channel Enhancement Mode
Field Effect Transistor**

PI5B3BA
TO-251
Halogen-Free & Lead-Free

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(on)}$	I_D
-40V	8mΩ	-74A

**Features**

- Pb-Free, Halogen Free and RoHS compliant.
- Low $R_{DS(on)}$ to Minimize Conduction Losses.
- Ohmic Region Good $R_{DS(on)}$ Ratio.
- Optimized Gate Charge to Minimize Switching Losses.

Applications

- Protection Circuits Applications.
- Logic/Load Switch Circuits Applications.

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS	SYMBOL	LIMITS	UNITS
Drain-Source Voltage	V_{DS}	-40	V
Gate-Source Voltage	V_{GS}	± 25	V
Continuous Drain Current ²	I_D	-74	A
		-46	
Pulsed Drain Current ¹	I_{DM}	-150	
Avalanche Current	I_{AS}	-48.9	
Avalanche Energy	E_{AS}	120	mJ
Power Dissipation	P_D	83	W
		33	
Junction & Storage Temperature Range	T_J, T_{stg}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$	1.5	62.5	°C / W
Junction-to-Ambient	$R_{\theta JA}$			

¹Pulse width limited by maximum junction temperature.

²Package limitation current is -55A.

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ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = -250μA	-40			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250μA	-1	-1.7	-3	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0V, V _{GS} = ±25V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -32V, V _{GS} = 0V			-1	μA
		V _{DS} = -30V, V _{GS} = 0V, T _J = 125 °C			-10	
Drain-Source On-State Resistance ¹	R _{DS(ON)}	V _{GS} = -4.5V, I _D = -15A		8.7	14	
		V _{GS} = -10V, I _D = -20A		6.4	8	mΩ
Forward Transconductance ¹	g _{fs}	V _{DS} = -5V, I _D = -20A		62		S
DYNAMIC						
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = -20V, f = 1MHz		3930		pF
Output Capacitance	C _{oss}			507		
Reverse Transfer Capacitance	C _{rss}			409		
Gate Resistance	R _g	V _{GS} = 0V, V _{DS} = 0V, f = 1MHz		3.3		Ω
Total Gate Charge ²	Q _g (V _{GS} =-10V)	V _{DS} = -20V, V _{GS} = -10V, I _D = -20A		88		nC
	Q _g (V _{GS} =-4.5V)			45		
Gate-Source Charge ²	Q _{gs}			10		
Gate-Drain Charge ²	Q _{gd}			21		
Turn-On Delay Time ²	t _{d(on)}	V _{DS} = -20V, I _D ≈ -20A, V _{GS} = -10V, R _{GEN} = 6Ω		18		nS
Rise Time ²	t _r			45		
Turn-Off Delay Time ²	t _{d(off)}			173		
Fall Time ²	t _f			122		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_J = 25 °C)						
Continuous Current ³	I _S				-51	A
Forward Voltage ¹	V _{SD}	I _F = -20A, V _{GS} = 0V			-1.3	V
Reverse Recovery Time	t _{rr}	I _F = -20A, dI _F /dt = 100A / μS		32		nS
Reverse Recovery Charge	Q _{rr}			18		nC

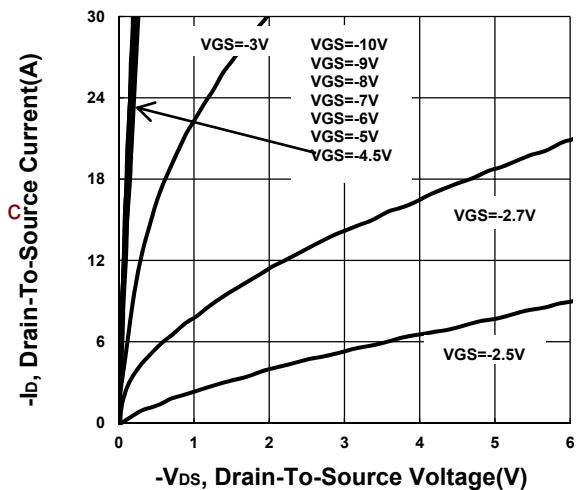
¹Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.²Independent of operating temperature.³Package limitation current is -55A.

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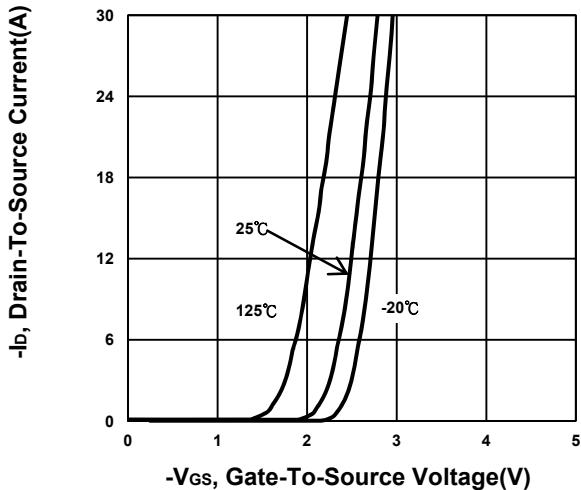
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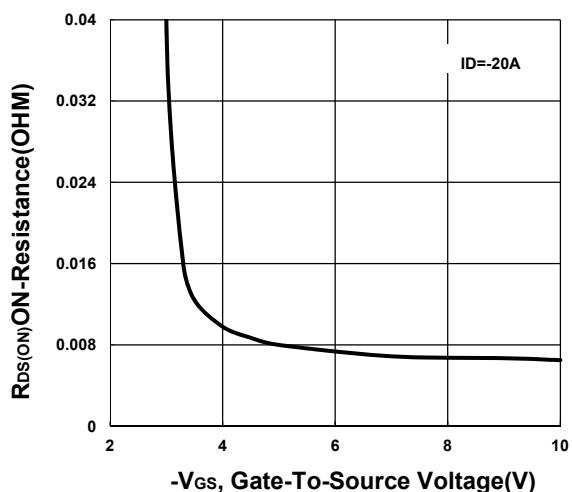
Output Characteristics



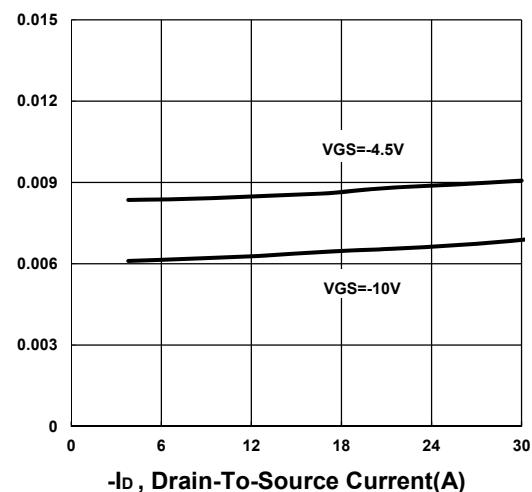
Transfer Characteristics



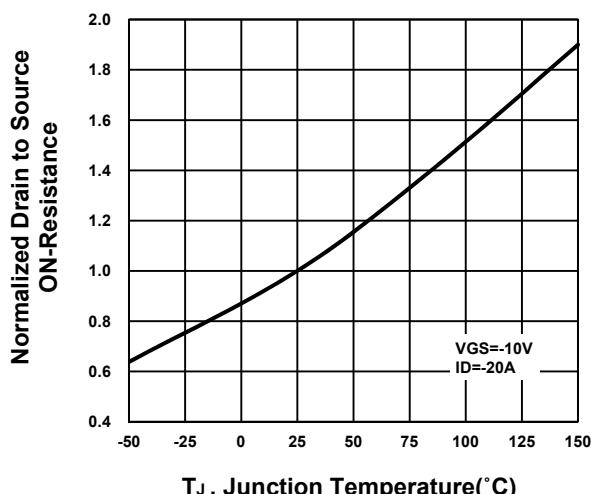
On-Resistance VS Gate-to-Source



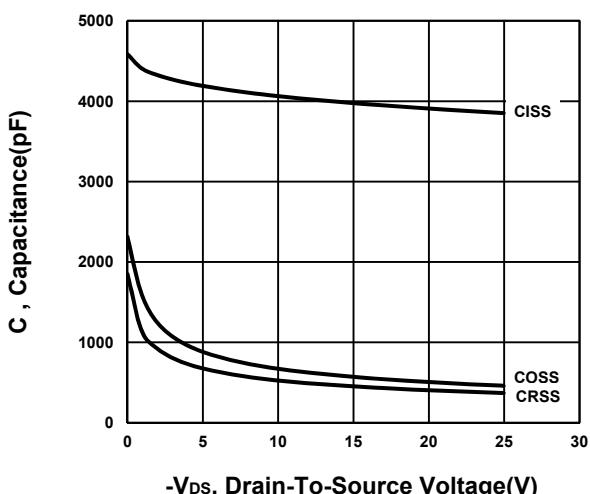
On-Resistance VS Drain Current

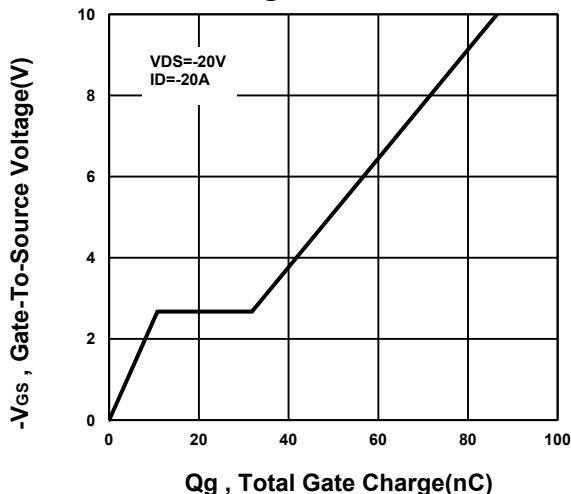
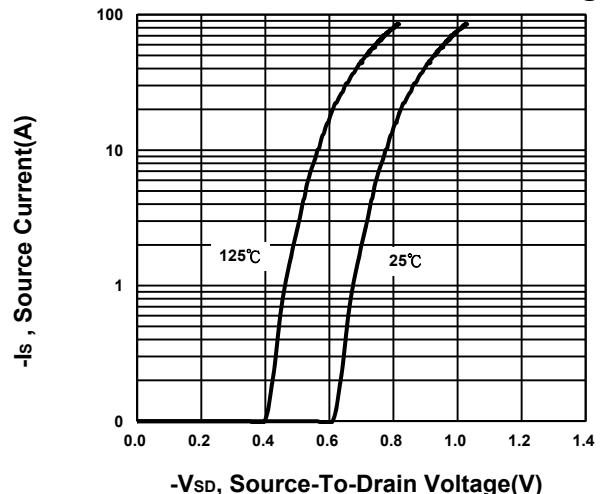
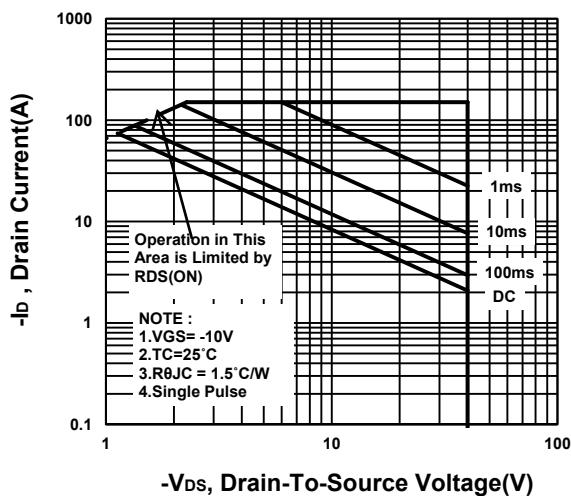
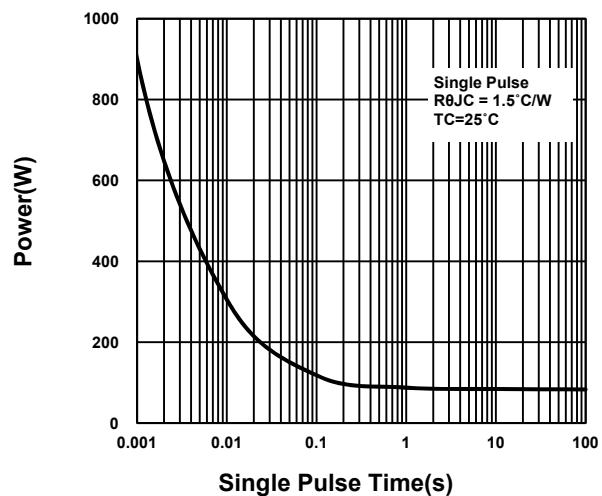


On-Resistance VS Temperature



Capacitance Characteristic



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Gate charge Characteristics**Source-Drain Diode Forward Voltage****Safe Operating Area****Single Pulse Maximum Power Dissipation****Transient Thermal Response Curve**